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# HCP1104 Series High Current Pressed Power Inductors

### **Description**

- 125°C maximum total temperature operation
- Low profile surface mount inductors
- 10mm x 11.5mm x 4.0mm package
- Pressed powder iron core material
- Enhanced core coating eliminates rusting and provides high insulation impedance
- Inductance range from 0.2µH to 0.9µH
- Current range from 42.0 Amps to 22 Amps
- Frequency range up to 1MHz

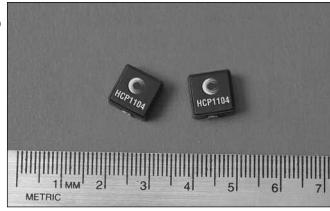
### **Applications**

- Notebook power
- VRM, multi-phase buck regulator
- DC-DC converters
- PC workstations/Servers
- Routers

#### **Environmental Data**

- Storage temperature range: -55°C to +125°C
- Operating temperature range: -55°C to +125°C (range is application specific)
- Solder reflow temperature: +260°C max. for 10 seconds maximum





### **Packaging**

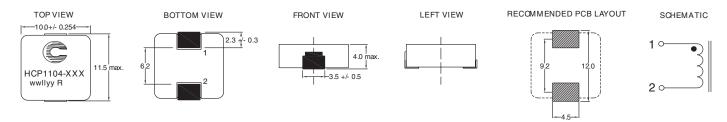
 Supplied in tape and reel packaging, 950 parts per reel

Part Number	Rated Inductance (µH)	OCL (1) μH ± 20%	Irms (2) Amperes	Isat (3) Amperes	DCR mΩ@20°C (Typical)	DCR mΩ@20°C (Maximum)	K-factor (4)
HCP1104-R20-R	0.20	0.20	32	42	0.7	0.9	505
HCP1104-R36-R	0.36	0.36	30	40	1.0	1.2	289
HCP1104-R45-R	0.45	0.45	30	35	1.25	1.4	334
HCP1104-R56-R	0.56	0.56	25	32	1.60	1.8	287
HCP1104-R90-R	0.90	0.90	22	25	2.30	2.5	168

<sup>(1)</sup> Open Circuit Inductance Test Parameters: 100kHz, 0.25V, 0.0Adc.

B p-p = K\*L\*ΔI, B-p-p: (Gauss), K: (K factor from table), L: (Inductance in uH), ΔI (Peak to peak ripple current in Amps).

#### **Mechanical Diagrams**



Dimensions are in millimeters.

wwlly = Date Code. R = Revision Level.

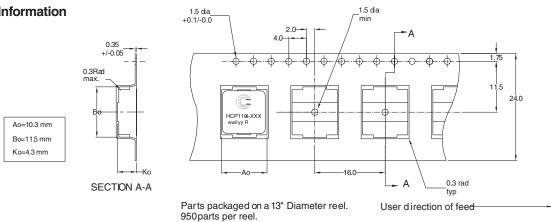
<sup>(2)</sup> Irms: DC current for an approximate ΔT of 40°C without core loss. Derating is necessary for AC currents. PCB layout, trace thickness and width, air-flow, and proximity of other heat generating components will affect the temperature rise. It is recommended that the temperature of the part not exceed 125°C under worst case operating conditions verified in the end application.

<sup>(3)</sup> Isat Amperes peak for approximately 20% rolloff (@20°C)(4) K-factor: Used to determine B p-p for core loss (see graph).



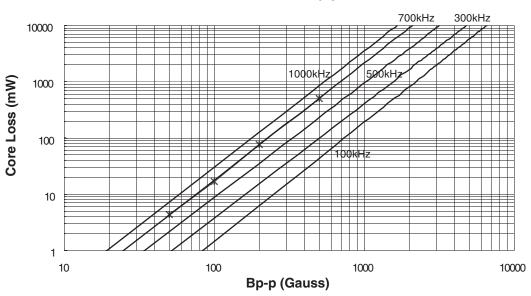
### HCP1104 Series High Current Pressed Power Inductors

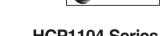
### **Packaging Information**



### **Core Loss**

### Core Loss vs Bp-p



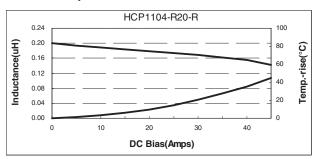


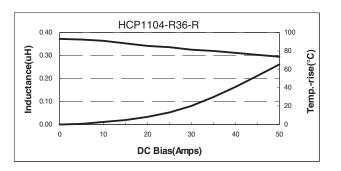
COILTRONICS

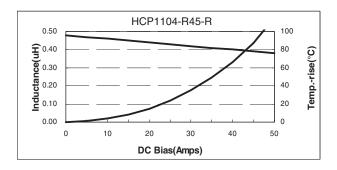


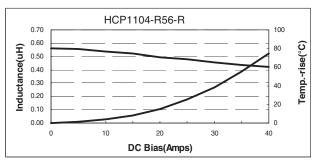
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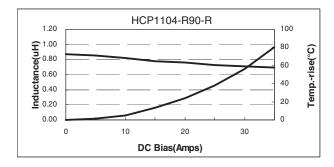
#### **Performance Graphs**













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